

Vishay General Semiconductor

High-Voltage Surface Mount Schottky Rectifier

High Barrier Technology for Improved High Temperature Performance



DO-214AB (SMC)

PRIMARY CHARACTERISTICS				
I _{F(AV)}	3.0 A			
V_{RRM}	90 V, 100 V			
I _{FSM}	100 A			
V _F	0.65 V			
I _R	20 μΑ			
T _J max.	175 °C			

FEATURES

- · Low profile package
- · Ideal for automated placement
- Guardring for overvoltage protection
- · Low power losses, high efficiency
- Low forward voltage drop
- · Low leakage current
- · High surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Solder dip 260 °C 40 s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, dc-to-dc converters, and polarity protection applications.

MECHANICAL DATA

Case: DO-214AB (SMC)

Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test, HE3 suffix for high reliability grade (AEC Q101 qualified), meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	SS3H9 SS3H10		UNIT	
Device marking code		MS9 MS10			
Maximum repetitive peak reverse voltage	V_{RRM}	90	100	V	
Working peak reverse voltage	V_{RWM}	90	100	V	
Maximum DC blocking voltage	V_{DC}	90	100	V	
Maximum average forward rectified current at: T _L = 115 °C	I _{F(AV)}	3.0		Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	100		А	
Peak repetitive reverse surge current at t _p = 2.0 μs, 1 kHz	I _{RRM}	1.0		Α	
Critical rate of rise of reverse voltage	dV/dt	10 000		V/µs	
Operating junction and storage temperature range	T _J , T _{STG}	- 65 to + 175		°C	

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CC	NDITIONS	SYMBOL	SS3H9 SS3H10		UNIT	
Maximum instantaneous forward voltage (1)	$I_F = 3.0 \text{ A}$ $I_F = 3.0 \text{ A}$	T _J = 25 °C T _J = 125 °C	V_{F}	0.8 0.65		V	
Maximum reverse current at rated V _R ⁽²⁾		T _J = 25 °C T _J = 125 °C	I _R	20 4		μA mA	

Notes:

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	SS3H9	SS3H10	UNIT	
Typical thermal resistance, junction to lead at T _L = 25 °C	$R_{ heta JL}$	20		°C/W	
Typical thermal resistance, junction to ambient (1)	$R_{\theta JA}$	50		C/VV	

Note:

(1) Units mounted on P.C.B. with 0.55 x 0.55" (14 x 14 mm) copper pad areas

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SS3H9-E3/57T	0.235	57T	850	7" diameter plastic tape and reel		
SS3H9-E3/9AT	0.235	9AT	3500	13" diameter plastic tape and reel		
SS3H9HE3/57T ⁽¹⁾	0.235	57T	850	7" diameter plastic tape and reel		
SS3H9HE3/9AT ⁽¹⁾	0.235	9AT	3500	13" diameter plastic tape and reel		

Note:

(1) Automotive grade AEC Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

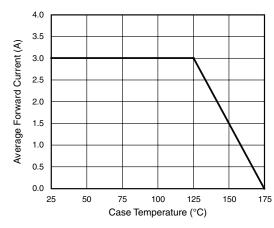


Figure 1. Forward Current Derating Curve

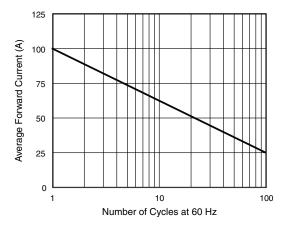


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current



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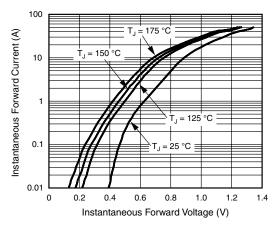


Figure 3. Typical Instantaneous Forward Characteristics

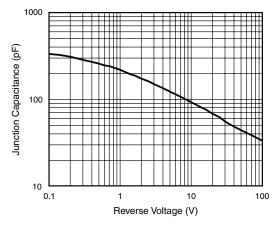


Figure 5. Typical Junction Capacitance

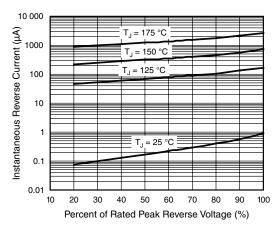


Figure 4. Typical Reverse Characteristics

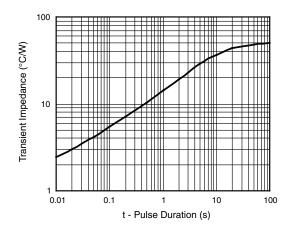
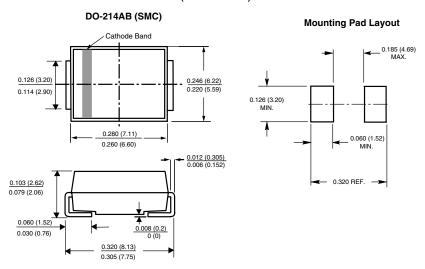


Figure 6. Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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Document Number: 91000 Revision: 18-Jul-08

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